

**INTEL<sup>®</sup>  
EXPERIENCE  
DAY**

# DISCLOSURES

Software and workloads used in performance tests may have been optimized for performance only on Intel microprocessors.

Performance tests, such as SYSmark and MobileMark, are measured using specific computer systems, components, software, operations and functions. Any change to any of those factors may cause the results to vary. You should consult other information and performance tests to assist you in fully evaluating your contemplated purchases, including the performance of that product when combined with other products.

For more information go to [www.intel.com/benchmarks](http://www.intel.com/benchmarks).

Performance results are based on testing as of several dates following result information and may not reflect all publicly available security updates. See configuration disclosure for details. No product or component can be absolutely secure.

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# СЕРВЕРНЫЕ ПРОДУКТЫ INTEL

Vasily . Lizunov @ intel . com

**CLOUDIFICATION EXPANSION  
AND SCALE TO THE POINT OF USE**

# DATA-CENTRIC ERA

**CLOUD**

**DELIVER NEW SERVICES FASTER TO HANDLE THE DELUGE OF DATA**

**COMMS**

**DELIVER OPERATIONAL EFFICIENCIES**

**ENTERPRISE**

**DELIVER SECURE INFRASTRUCTURE TO PROTECT DATA PRIVACY**

**MORE THAN  
50%**

**OF WORLD'S DATA WAS CREATED  
IN THE PAST TWO YEARS**

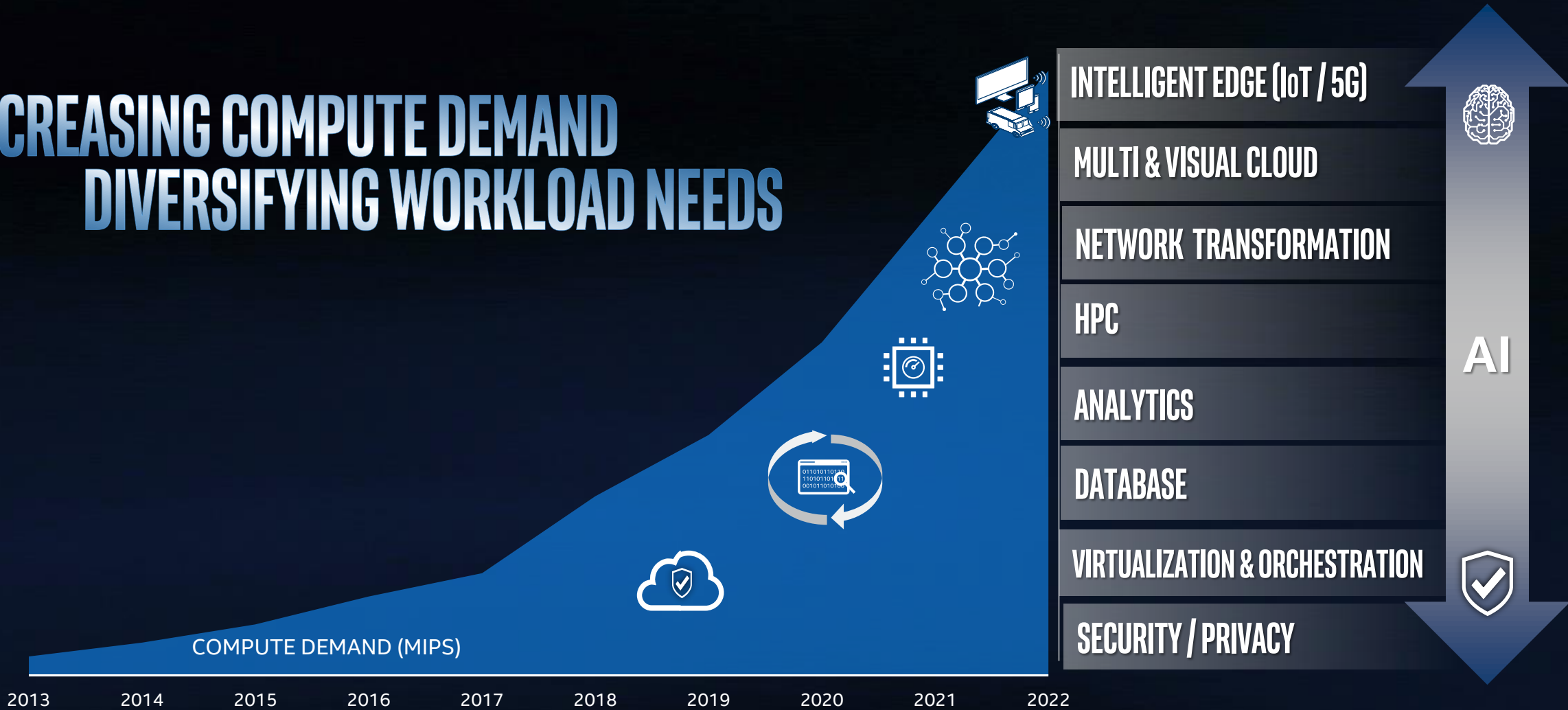
**AND ONLY  
2%  
HAS BEEN ANALYZED**

Source: Data Age 2025, sponsored by Seagate with data from IDC Global DataSphere, Nov 2018



# DRIVING BUSINESS TRANSFORMATION

## INCREASING COMPUTE DEMAND DIVERSIFYING WORKLOAD NEEDS



Source: Intel analysis

# DATA-CENTRIC INFRASTRUCTURE FOCUS

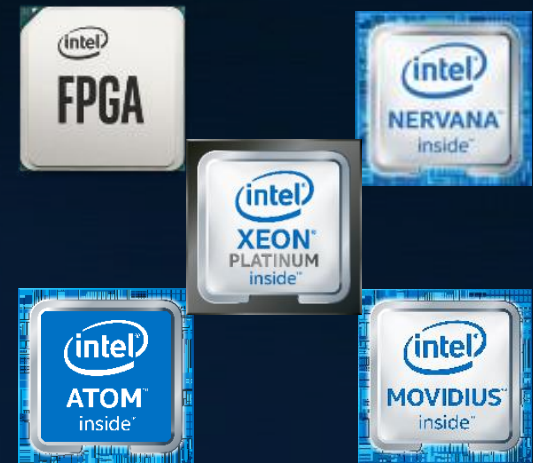
## MOVE FASTER



## STORE MORE



## PROCESS EVERYTHING



## SOFTWARE & SYSTEM-LEVEL OPTIMIZED



ANNOUNCED ON APRIL 2, 2019

# 2019 DATA-CENTRIC PORTFOLIO

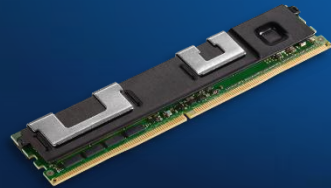
## MOVE FASTER

INTEL®  
ETHERNET  
800 SERIES



## STORE MORE

INTEL®  
OPTANE™ DC  
PERSISTENT MEMORY



DUAL PORT  
INTEL®  
OPTANE™ DC SSD



INTEL®  
QLC 3D NAND SSD



## PROCESS EVERYTHING

INTEL®  
XEON® D-1600



2ND GENERATION  
INTEL®  
XEON® SCALABLE



INTEL®  
AGILEX™ FPGA



SECOND GENERATION  
INTEL® XEON® SCALABLE PROCESSORS

**>50**  
STANDARD SKUS

**DOZENS**  
CUSTOM SKUS

**8 TO 56**  
CORES PER SOCKET

**>4.5TB**  
MEMORY PER SOCKET

**1 TO 8**  
SOCKETS

INTEL® OPTANE™ DC PERSISTENT MEMORY

INTEL® DEEP LEARNING BOOST

INTEL® SPEED SELECT TECHNOLOGY

NETWORK-OPTIMIZED SKUS

CLOUD-OPTIMIZED SKUS

SECURITY MITIGATIONS



BUILDING ON 20 YEARS OF DATA CENTER PROCESSOR INNOVATION



# INTRODUCING SECOND GENERATION INTEL® XEON® SCALABLE PROCESSORS

INTEL® XEON®  
PLATINUM 9200  
PROCESSORS



A NEW CLASS OF  
ADVANCED  
PERFORMANCE

INTEL® XEON®  
PLATINUM 8200  
PROCESSORS



INTEL® XEON®  
GOLD 6200  
PROCESSORS



INTEL® XEON®  
GOLD 5200  
PROCESSORS



INTEL® XEON®  
SILVER 4200  
PROCESSORS



INTEL® XEON®  
BRONZE 3200  
PROCESSORS



**BUILT-IN  
VALUE**

**UNINTERRUPTED  
LEADERSHIP WORKLOAD  
PERFORMANCE**

**GROUNDBREAKING  
MEMORY INNOVATION**

**EMBEDDED  
ARTIFICIAL INTELLIGENCE  
ACCELERATION**

**HARDWARE ENHANCED  
SECURITY**

**ENHANCED  
AGILITY & UTILIZATION**

# INTEL® XEON® SCALABLE PLATFORM & PROCESSOR ROADMAP





# INTEL® XEON® D-1600 PROCESSOR

INTEL® QUICKASSIST TECHNOLOGY | INTEL® ETHERNET | INTEL® VIRTUALIZATION TECHNOLOGY

## COMPUTE

UP TO **1.29X MORE**  
INTEGER THROUGHPUT<sup>1</sup>

## NETWORK

UP TO **1.25X MORE**  
PACKET FORWARDING<sup>2</sup>

## STORAGE

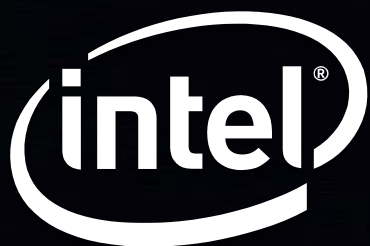
UP TO **1.4X HIGHER**  
READ/WRITE THROUGHPUT<sup>3</sup>

UP TO **2.7X LOWER**  
LATENCY<sup>3</sup>



Intel's compilers may or may not optimize to the same degree for non-Intel microprocessors for optimizations that are not unique to Intel microprocessors. These optimizations include SSE2, SSE3, and SSSE3 instruction sets and other optimizations. Intel does not guarantee the availability, functionality, or effectiveness of any optimization on microprocessors not manufactured by Intel. Microprocessor-dependent optimizations in this product are intended for use with Intel microprocessors. Certain optimizations not specific to Intel microarchitecture are reserved for Intel microprocessors. Please refer to the applicable product User and Reference Guides for more information regarding the specific instruction sets covered by this notice.





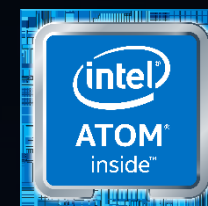
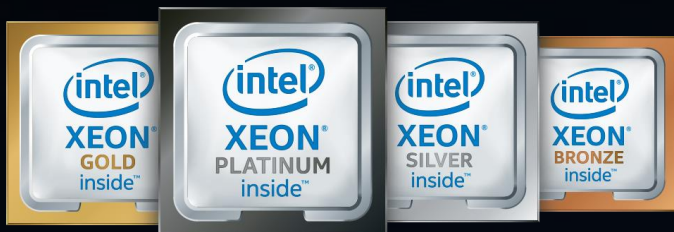
**INTEL OFFERS A PORTFOLIO OF PRODUCTS FOR ADVANCED DATA-CENTRIC INTELLIGENCE**



**TO BUILD AND ACCELERATE DATA-DRIVEN**



**SERVICES AND SOLUTIONS INTEGRATED WITH ENDPOINTS DEVICES**



**INTEL® XEON® SCALABLE PROCESSOR**  
**BEST PERFORMANCE, MOST SCALABLE**

DESIGNED FOR TRADITIONAL OPERATING ENVIRONMENTS WITH FLEXIBLE OPERATING SPACE AND POWER

**INTEL® XEON® D PROCESSOR**  
**OPTIMIZED FOR DENSITY, LOWER POWER**

DESIGNED FOR ENVIRONMENTS CONSTRAINED BY OPERATING SPACE AND POWER

**INTEL ATOM® C PROCESSOR**  
**PURPOSE-BUILT FOR VERY LOW POWER**

DESIGNED FOR ENVIRONMENTS CONSTRAINED BY PHYSICAL SIZE AND EXTREME TEMPERATURES

**INTEL® XEON® E PROCESSOR**  
**ENTRY SERVERS & EDGE APPLIANCES**

DESIGNED FOR TRADITIONAL OPERATING ENVIRONMENTS AND SMALL BUSINESS CUSTOMERS



# INTEL ATOM<sup>®</sup> C3000 PROCESSOR LANDSCAPE

## Base Stations

4G/5G base stations delivering SDN and NFV to the network edge



## Routers & Switches

Low power, intelligent routers and switches supporting SDN and NFV



## Storage

Energy efficient entry storage, entry SAN/NAS, and cold storage



## Security

VPN, firewall, ADC, IPsec and WAN acceleration appliances



## Web Servicing

Dedicated static web hosting and memory caching appliances



## Internet of Things

Low power intelligence at the edge from smart buildings, industrial IoT and more



# Tremont: Top-level Design Targets

Single thread performance

Networking

- Performance/mW
- Performance/mm<sup>2</sup>
- New instructions

Battery life

- Performance/mW



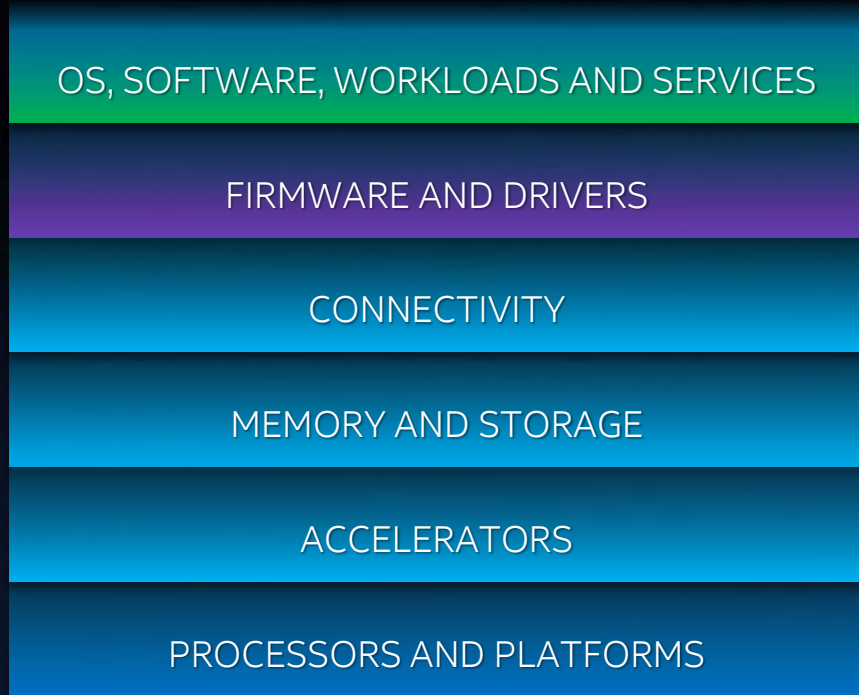


# Summary

- Tremont: Intel's next generation low power x86 microarchitecture
- Advancements on ISA, microarchitecture, security, and power management
- Out of order front end and 10 wide execution port back-end
- Significant IPC improvement vs. prior Intel low power x86 architectures
- Targeting a wide variety of products across client, data center, 5G networking and Internet of Things

# DELIVERING DATA-CENTRIC PLATFORM LEADERSHIP

OVER 20 YEARS OF INTEL® XEON® PLATFORM LEADERSHIP



intel LIBRARIES AND FRAMEWORKS intel ENABLING AND SUPPORT intel select solution

intel SOFTWARE intel DRIVERS intel FIRMWARE

intel ETHERNET intel OMNI-PATH FABRIC intel SILICON PHOTONICS

intel OPTANE DC PERSISTENT MEMORY intel OPTANE DC SOLID STATE DRIVE intel QLC 3D NAND intel NAND

intel STRATIX 10 inside intel ARRIA 10 inside FPGAs intel NERVANA inside NNPs intel QUICKASSIST intel GRAPHICS

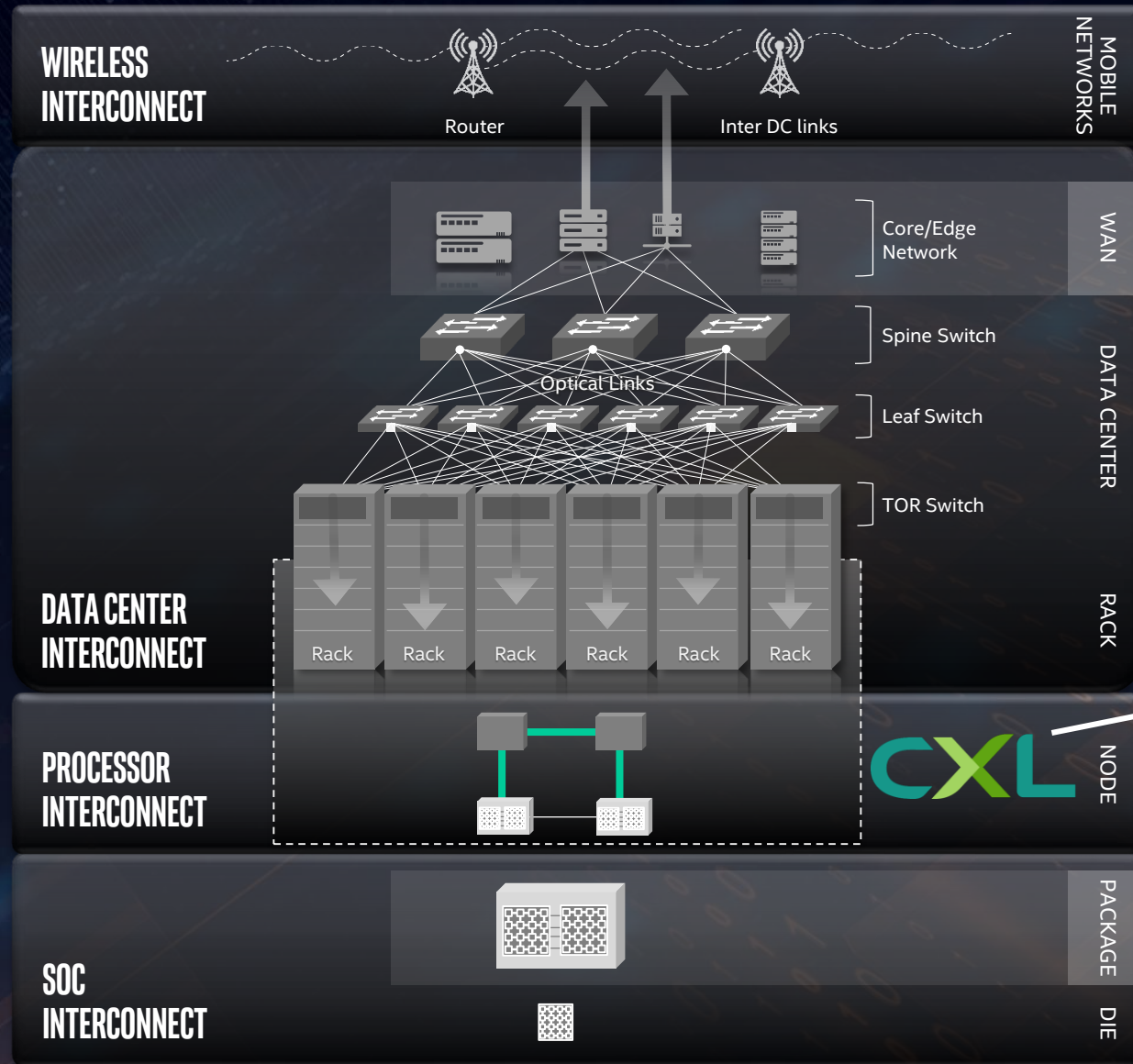
intel XEON PLATINUM inside intel AGILEX inside intel STRATIX 10 inside intel NERVANA inside intel CHIPSET intel CPU INSTRUCTION ACCELERATORS intel CPU PACKAGING TECHNOLOGY

END-TO-END PLATFORM INNOVATIONS TO DELIVER UNPRECEDENTED SCALE AND UTILIZATION

NOT A COMPREHENSIVE LIST OF PRODUCTS AND CAPABILITIES  
DATES, DETAILS AND INFORMATION ARE SUBJECT TO CHANGE WITHOUT NOTICE



# PROCESSOR INTERCONNECT



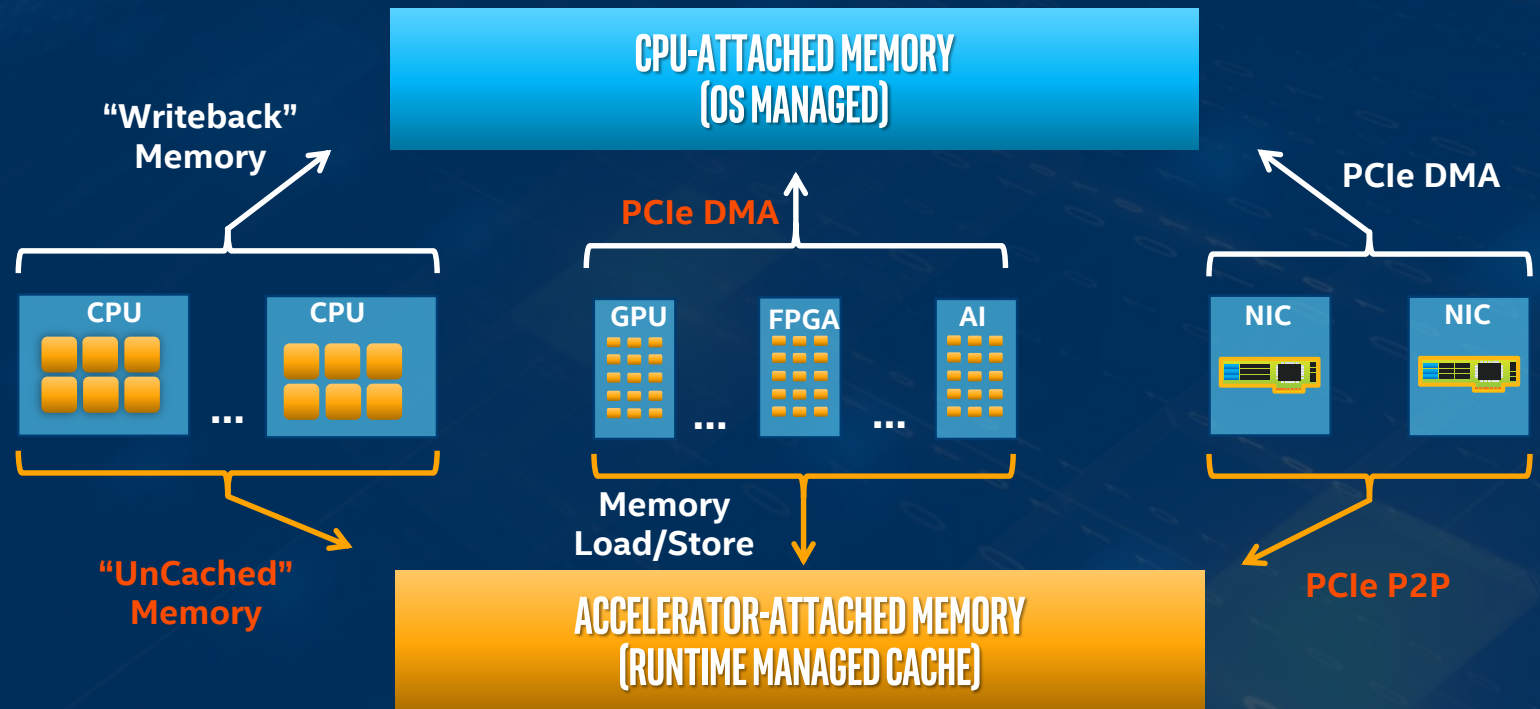
**CXL: A NEW CLASS OF INTERCONNECT FOR DEVICE CONNECTIVITY**



# WHY A NEW CLASS OF INTERCONNECT?

MOVE PAST THE PCIe LIMITERS ON HETEROGENEOUS COMPUTING AND SERVER DISAGGREGATION USAGES

- PCIe creates isolated memory pools with an inefficient mish-mash of access mechanisms.
- Moving operands and results back and forth between accelerators and devices is painful and inefficient
- Resource sharing is all but disallowed.
- Latencies are an order of magnitude off of what is needed to enable disaggregated memory.

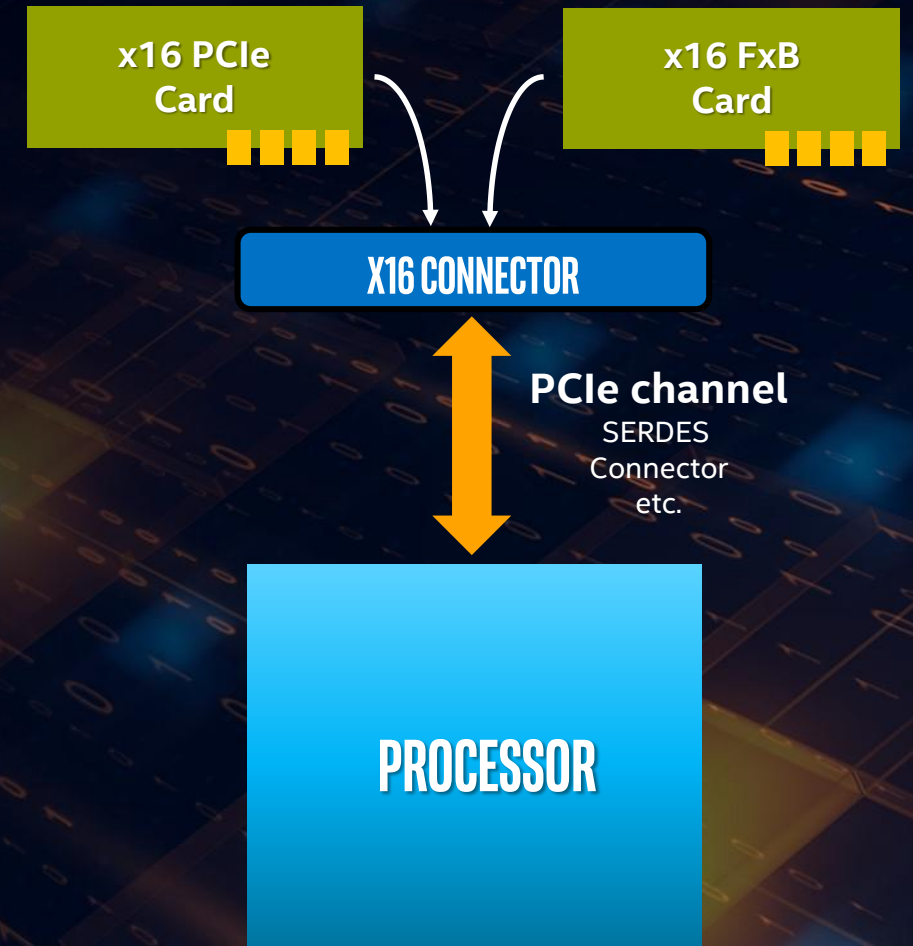


INTERCONNECT DAY

APRIL 2019

# WHAT IS CXL?

- CXL is an alternate protocol that runs across the standard PCIe physical layer
- CXL uses a flexible processor port that can auto-negotiate to either the standard PCIe transaction protocol or the alternate CXL transaction protocols
- First generation CXL aligns to 32 Gbps PCIe Gen5
- CXL usages expected to be key driver for an aggressive timeline to PCIe Gen6

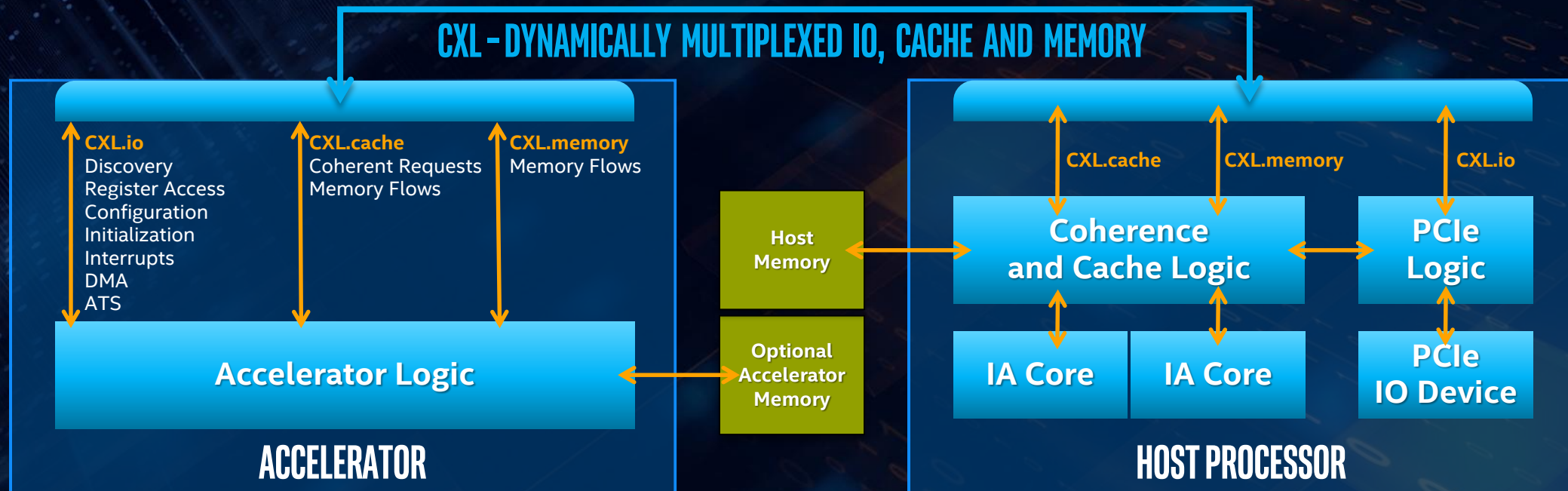




# CXL PROTOCOLS

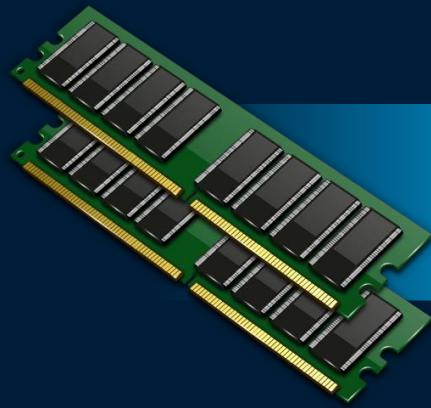
**THE CXL TRANSACTION LAYER IS COMPRISED OF 3 DYNAMICALLY MULTIPLEXED SUB-PROTOCOLS ON A SINGLE LINK:**

- CXL.io – Discovery, configuration, register access, interrupts, etc.
- CXL.cache – Device access to processor memory
- CXL.memory – Processor access to device attached memory

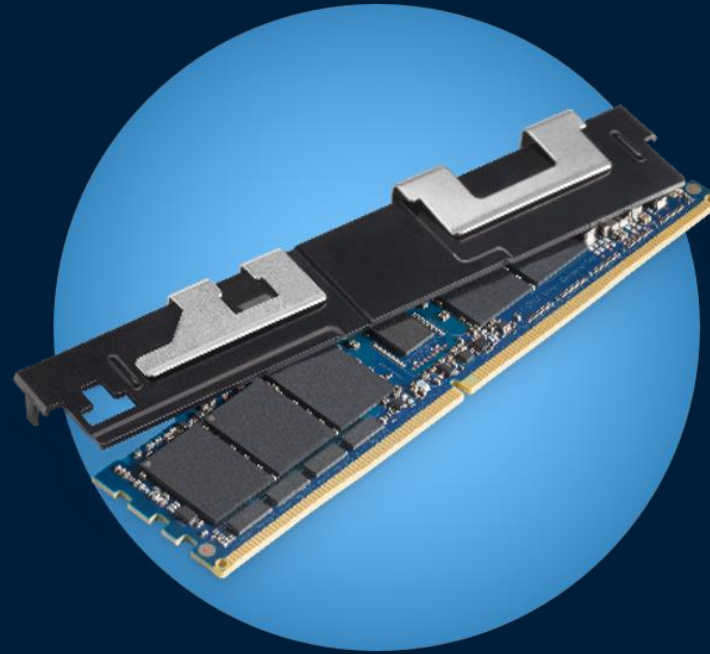




# INTRODUCING INTEL® OPTANE™ DC PERSISTENT MEMORY



**FAST MEMORY**



**ENHANCE DATA INSIGHTS BY  
REDEFINING THE MEMORY AND  
STORAGE HIERARCHY**

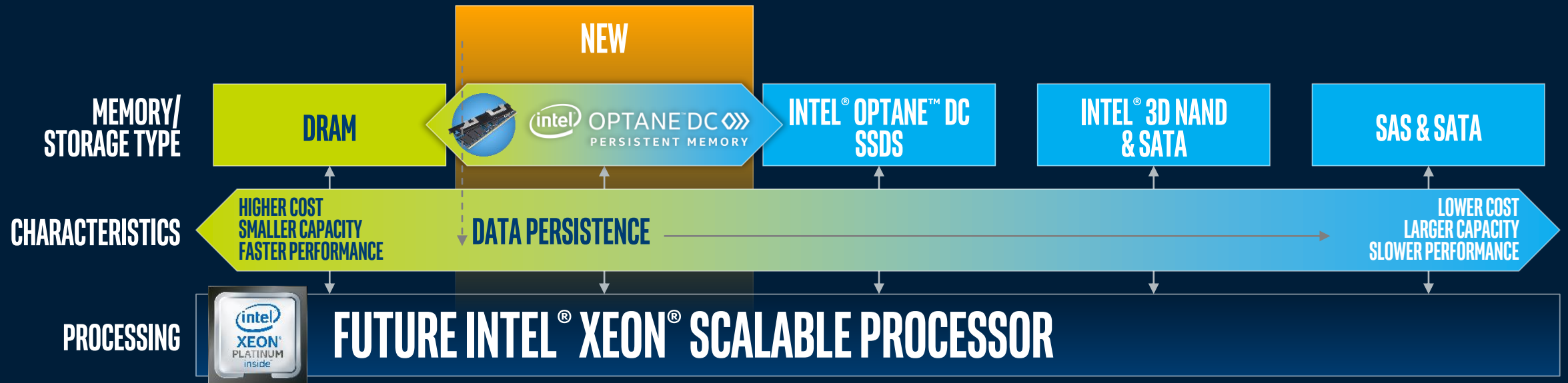


**SIZE AND DATA PERSISTENCE  
OF STORAGE**

Supported on future  
Intel® Xeon® Scalable Processors  
Platinum and Gold SKUs



# REDEFINING THE MEMORY AND STORAGE HIERARCHY



PERFORMANCE OF MEMORY, PERSISTENCE OF STORAGE.  
FLEXIBLE AND SCALABLE TO ACCELERATE YOUR DATA INSIGHTS.

# OPERATING MODES

## “APP DIRECT” MODE

APP/WORKLOAD DIRECT ACCESS TO  
HIGH SPEED, HIGH CAPACITY STORAGE



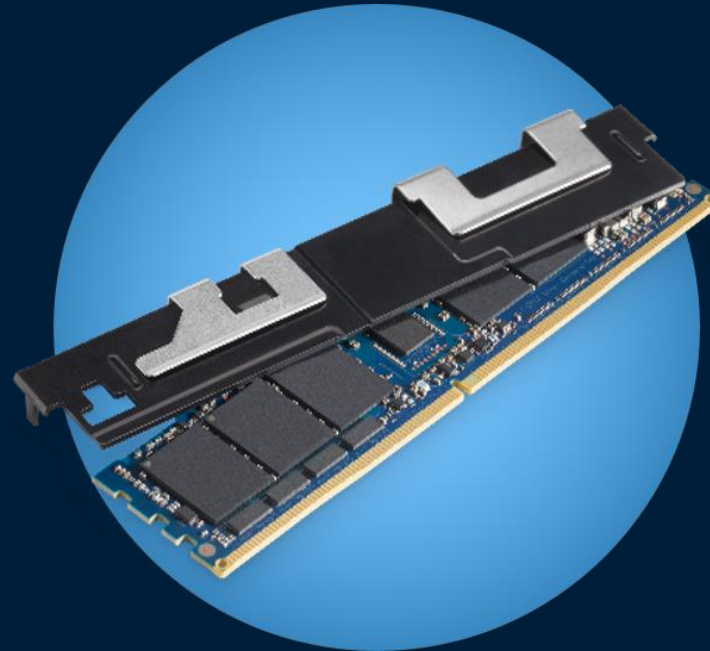
Persistent and much  
higher data capacity



High availability/  
less downtime



Significantly faster  
storage



 **OPTANE™ DC**   
PERSISTENT MEMORY

## MEMORY MODE

PLATFORM/OS/APP ACCESS TO  
HIGH SPEED, HIGH CAPACITY MEMORY



High capacity  
Targeting >1.2X More VMs<sup>1</sup>



Affordable capacity  
128GB, 256GB and 512GB  
Modules



Ease of adoption  
No code changes required

## BUILT-IN FLEXIBILITY TO USE BOTH MODES SIMULTANEOUSLY

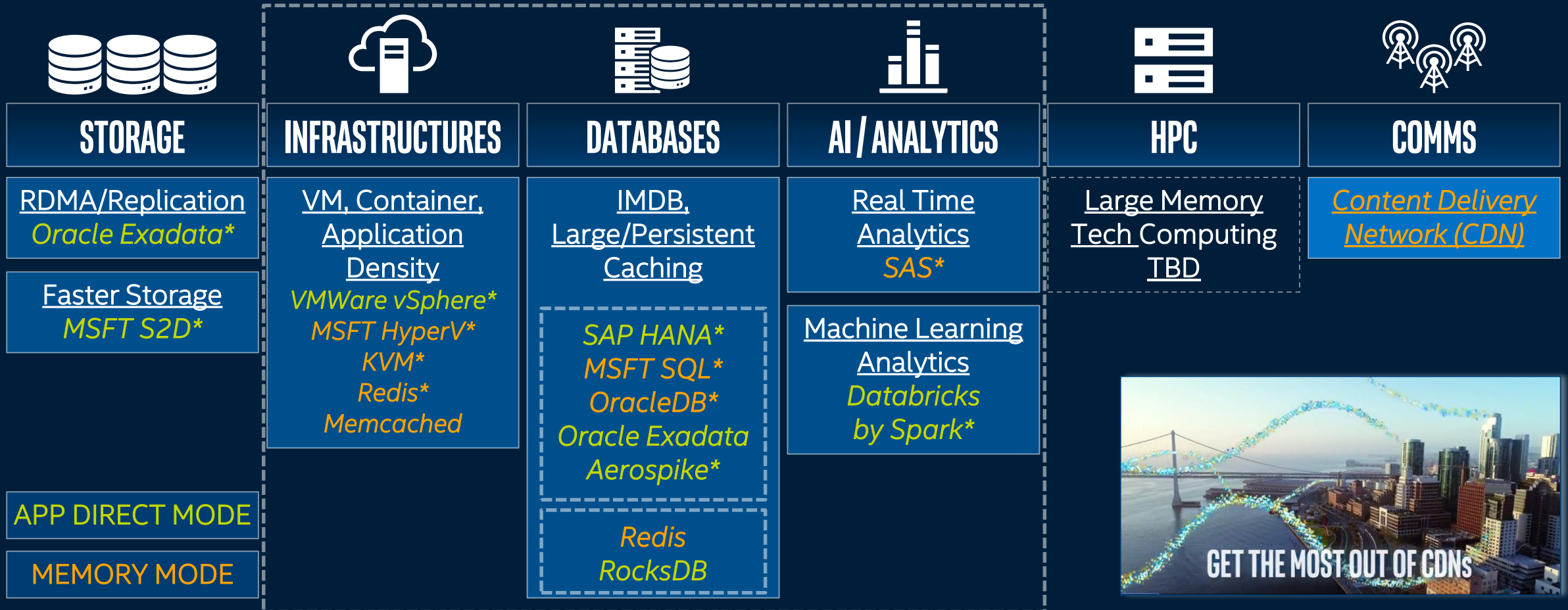
<sup>1</sup>Performance results are based on testing as of dates shown in configuration and may not reflect all publicly available security updates. See configuration disclosure for details. No product or component can be absolutely secure. For more complete information about performance and benchmark results, visit [www.intel.com/benchmarks](http://www.intel.com/benchmarks).



# INTEL® OPTANE™ DC PERSISTENT MEMORY



TARGET WORKLOADS WITH APPLICATION SUPPORT FOR LAUNCH



REVENUE-FOCUSED + HIGHEST AEP AFFINITY



PERSISTENT MEMORY FOR SEAMLESS CONTENT DELIVERY

\*Other names and brands may be claimed as the property of others.

accenture

◀EROSPIKE

AIC

Alibaba Group  
阿里巴巴集团

ALTIBASE

Apache CASSANDRA™

APACHE SPARK™

AsialInfo  
亚信科技

Atos

aws

Baidu Cloud

宝信软件  
BAOSIGHT

BONC 东方国信

CISCO

cloudera

COLFAX  
Customized Solutions

CRAY

databricks

DATASTAX

DELL EMC

FUJITSU

GBASE®

GIGABYTE™

GIGASPACES  
innovate with confidence

Google Cloud

H3C

hazelcast

Hewlett Packard  
Enterprise

海鑫科金  
HISIGN TECHNOLOGY

HUAWEI

IBM

inspur

inventec

JABIL

人大金仓  
Kingbase

Kingsoft Cloud  
KS CLOUD

kx

Lenovo

Microsoft

NARI  
国电南瑞  
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NetApp

Neusoft

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PENGUIN  
COMPUTING

QCT

redhat

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SUNJESOFT  
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TYAN

ubuntu®

UNICOM Engineering, Inc.  
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Virtuozzo

vmware®

wiwynn®

World Wide Technology

# DEVELOPER RESOURCES FOR INTEL® OPTANE™ DC PERSISTENT MEMORY

Find the PMDK  
(Persistent Memory Development Kit)  
at <http://pmem.io/pmdk/>

## Getting Started

- Intel IDZ persistent memory - <https://software.intel.com/en-us/persistent-memory>
- Entry into overall architecture - <http://pmem.io/2014/08/27/crawl-walk-run.html>
- Emulate persistent memory - <http://pmem.io/2016/02/22/pm-emulation.html>

Persistent Memory  
Programming Video Series -  
<https://software.intel.com/en-us/persistent-memory/get-started/series>

## Linux Resources

- Linux\* Community Pmem Wiki - <https://nvdimm.wiki.kernel.org/>
- Pmem enabling in SUSE Linux Enterprise 12 SP2 - <https://www.suse.com/communities/blog/nvdimm-enabling-suse-linux-enterprise-12-service-pack-2/>

## Windows\* Resources

- Using Byte-Addressable Storage in Windows Server 2016 - <https://channel9.msdn.com/Events/Build/2016/P470>
- Accelerating SQL Server 2016 using Pmem - <https://channel9.msdn.com/Shows/Data-Exposed/SQL-Server-2016-and-Windows-Server-2016-SCM--FAST>

## Other Resources

- SNIA Persistent Memory Summit 2018 - <https://www.snia.org/pm-summit>
- Intel manageability tools for Pmem - <https://01.org/ixpdimm-sw/>



# FOCUSED INVESTMENTS TO ACCELERATE HPC & AI

## ADVANCED ARCHITECTURES



+ Quantum & Neuromorphic

COMPUTE ARCHITECTURES  
FOR ALL YOUR WORKLOADS

## MANUFACTURING EXCELLENCE

### PROCESS



### PACKAGING



ADVANCED PACKAGING  
FOR HETEROGENEOUS INTEGRATION

## INTELLIGENT INTERCONNECT



ADVANCED HIGH  
PERFORMANT FABRICS

INTERCONNECT BEYOND "I/O"

## SIMPLIFIED PROGRAMMING



UNIFIED SINGLE SOFTWARE ABSTRACTION  
AND DOMAIN-SPECIFIC LIBRARIES

## TRANSFORMING MEMORY & STORAGE



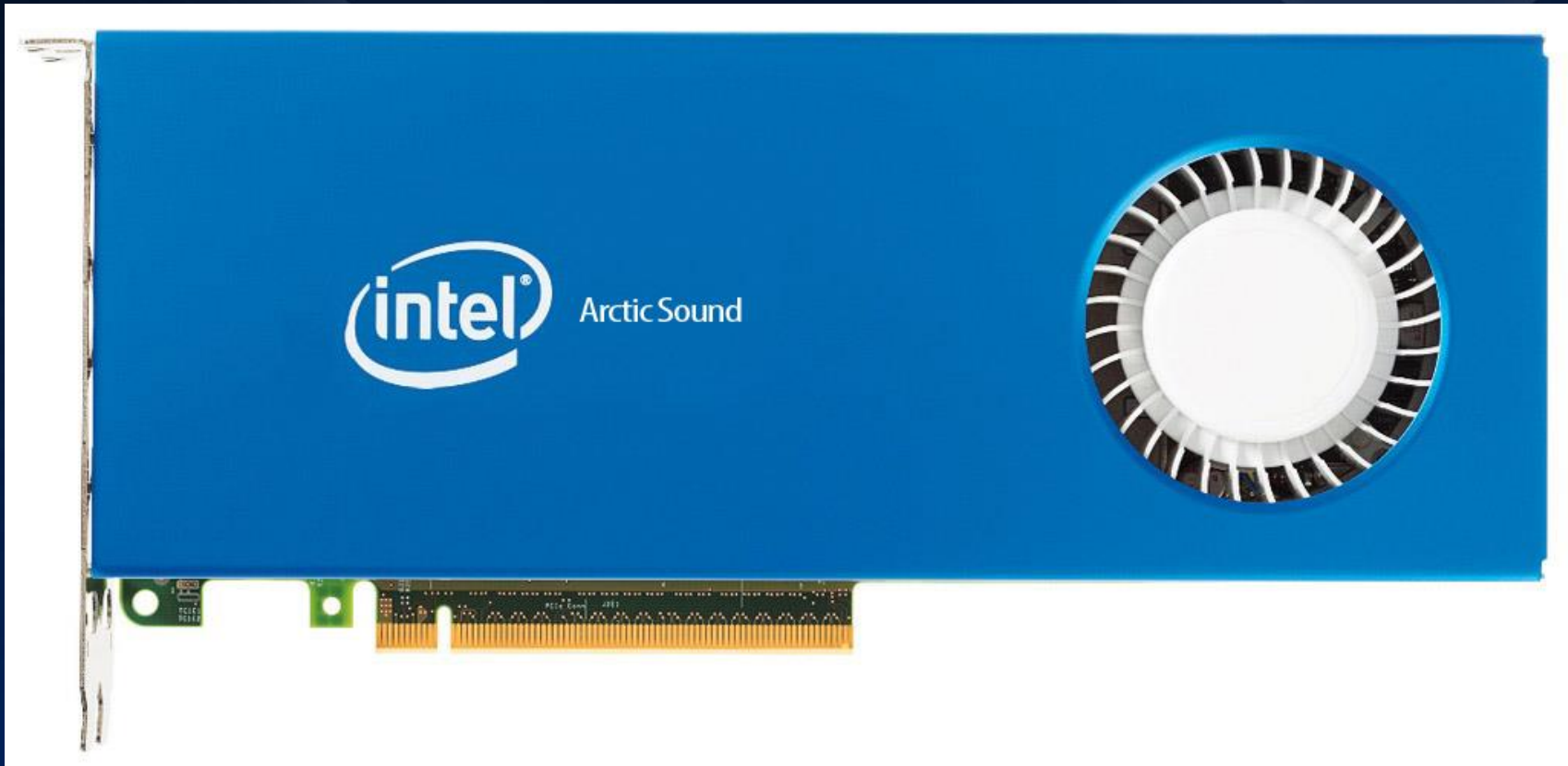
RE-ARCHITECTING THE MEMORY  
HIERARCHY AND FILE SYSTEMS

## BUILT-IN SECURITY

SECURITY AT ALL LEVELS:  
CORE, SOC, BOARD,  
PLATFORM, & SOFTWARE

UNIQUELY POSITIONED TO IMPLEMENT  
SECURITY TECHNOLOGIES AT EVERY LEVEL

GROWING THE ECOSYSTEM AND ADVANCING HPC & AI  
THROUGH OPEN STANDARDS





# ACCELERATING AI

LEADERSHIP PERFORMANCE FOR DATA LEVEL PARALLEL AI WORKLOADS



**7NM PROCESS TECHNOLOGY**

**EMIB (2D) AND FOVEROS (3D) TECHNOLOGY**

***POWERING AURORA***  
**DELIVERED IN 2021**



ANNOUNCED ON APRIL 2, 2019

# 2019 DATA-CENTRIC PORTFOLIO

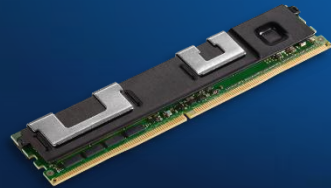
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ETHERNET  
800 SERIES



## STORE MORE

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PERSISTENT MEMORY



DUAL PORT  
INTEL®  
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XEON® D-1600



2ND GENERATION  
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XEON® SCALABLE



INTEL®  
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**ВОПРОСЫ ?**

**INTEL® EXPERIENCE DAY**

